desktop and server applications.

PCI Express is a third generation I/O architecture. PCI-SIG recently released the PCI Express specification to move the PCI interface to faster signaling speeds and provide greater bandwidth. PCI Express incorporates point-to-point signaling using low voltage differential pairs operating at 2.5 Gbps each direction. This version of PCI Express is expected to be used in desktop PCs, workstations and servers.

PCI Express provides scaleable bandwidth. A 1-lane (1X) connector can support many of the conventional PCI functions found in client systems, while a 16-lane (16X) connector provides the bandwidth needed for supporting graphics processing, InfiniBandt and 10G Fibre Channel.

Features and Benefits

- Complies with the PCI-SIG specification for seamless desktop PCI Express implementation
- Supports 2.5 Gbps data transfer for faster signaling
- Scaleable design maximizes card interoperability, allowing customers to plug add-in cards of smaller or equal bandwidth into the edgecard connector

SPECIFICATIONS

Reference Information

Product Specification: PS-87715-200 Packaging: Tray Use with: PCI Express add-in cards **Designed in: Millimeters**

Electrical

Voltage: 50V AC (RMS)/DC Current: 1.1A per pin Contact Resistance: Initial - 30 milliohms max. Change over life - 10 milliohms max. Dielectric Withstanding Voltage: 500V DC Insulation Resistance: 1000 Megohms min.

ORDERING INFORMATION

Order No.	Description	PC Tail	Plating
87715-3002	1-lane PCI Express Edgecard	2.54mm (.100")	15µ" Gold
87715-3102	4-lane PCI Express Edgecard		
87715-3202	8-lane PCI Express Edgecard		
87715-3302	16-lane PCI Express Edgecard		

* PCI Express is a trademark of PCI-SIG

WWW.DZSC †InfiniBand is a trademark of the InfinBand (TM) Trade Association

Enable hotswap add-in cards for plug-andplay applications

Simple through hole layout for easy PCB processing



Mechanical

Card Insertion Force: 1.15N max. per contact pair Card Withdrawal Force: 0.15N min. per contact pair Contact Retention to Housing: 5N min. Durability: 50 cycles

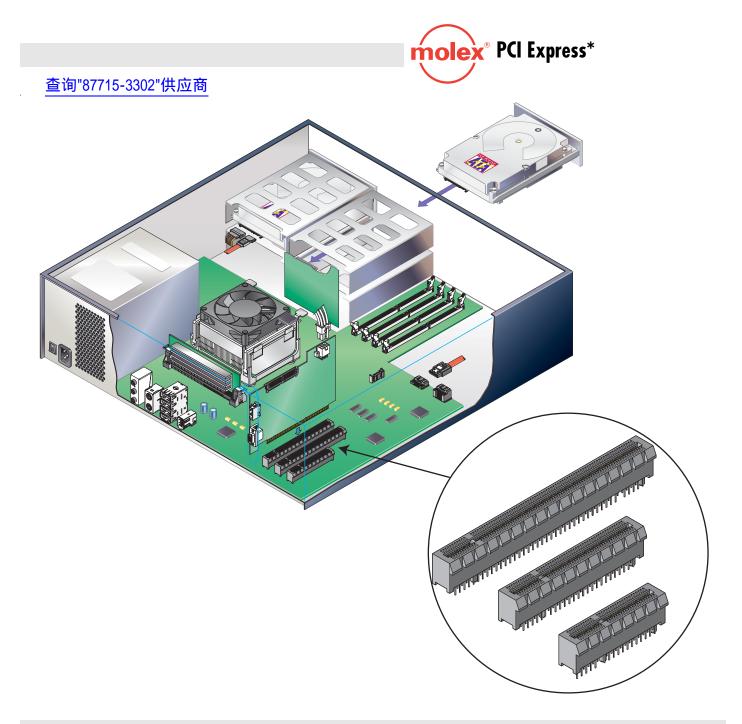
Physical

molex[®] PCI Express*

Housing: Nylon, UL 94V-O, various colors **Contact: Phosphor Bronze** Plating: Contact Area - Gold Flash, 15p" or 30p" Gold PC Tail Area - Tin Lead Resistance to Solder Heats: Connector on applicable PCB can float on molten solder at +260°C for ten seconds

Operating Temperature: +15 to +85° C





APPLICATIONS

- Desktop and tower PCs
- Workstations
- Servers

*PCI Express is a trademark of PCI-SIG

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